1N5404 and 1N5406 are Preferred Devices

Axial-Lead Standard Recovery Rectifiers

Lead mounted standard recovery rectifiers are designed for use in power supplies and other applications having need of a device with the following features:

Features

- High Current to Small Size
- High Surge Current Capability
- Low Forward Voltage Drop
- Void-Free Economical Plastic Package
- Available in Volume Quantities
- Plastic Meets UL 94 V–0 for Flammability
- These are Pb-Free Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode Indicated by Polarity Band



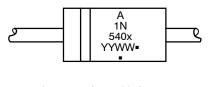
ON Semiconductor®

| STANDARD RECOVERY |
|-------------------|
| RECTIFIERS |
| 50-1000 VOLTS |
| 3.0 AMPERES |



AXIAL LEAD CASE 267-05 STYLE 1

MARKING DIAGRAM



A = Assembly Location 1N540x = Device Number x = 0, 1, 2, 4, 6, 7 or 8 YY = Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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MAXIMUM RATINGS

| Rating | Symbol | 1N5400 | 1N5401 | 1N5402 | 1N5404 | 1N5406 | 1N5407 | 1N5408 | Unit |
|--------------------------------------------------------------------------------------------------------------|--------------------------------------------------------|------------------------------|--------|--------|--------|--------|--------|--------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Non-repetitive Peak Reverse Voltage | V _{RSM} | 100 | 200 | 300 | 525 | 800 | 1000 | 1200 | V |
| Average Rectified Forward Current (Single Phase Resistive Load, 1/2 in. Leads, T _L = 105°C) | lo | 3.0 | | | | A | | | |
| Non-repetitive Peak Surge Current (8 ms Single Half-Sine-Wave) | I _{FSM} | 200 (one cycle) | | | | А | | | |
| Operating and Storage Junction Temperature Range | T _J T _{stg} | – 65 to +150 – 65 to +175 | | | | °C | | | |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Тур | Unit |
|-------------------------------------------------------------------------|-----------------|-----|------|
| Thermal Resistance, Junction-to-Ambient (PC Board Mount, 1/2 in. Leads) | $R_{\theta JA}$ | 53 | °C/W |

ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Min | Тур | Max | Unit |
|-----------------------------------------------------------------------------------|----------------|-----|-----|----------|------|
| Forward Voltage (I _F = 3.0 A, T_A = 25°C) | VF | - | - | 1.0 | V |
| Reverse Current (Rated DC Voltage) $T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$ | I _R | - | - | 10 50 | μΑ |

Ratings at 25°C ambient temperature unless otherwise specified.

60 Hz resistive or inductive loads.

For capacitive load, derate current by 20%.

NOTE 1 — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction-to-ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured. TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{J} \textbf{A}}$ in still air Lead Length, L (IN) Mounting $\textbf{R}_{\theta \textbf{J} \textbf{A}}$ Method 1/8 1/4 1/2 3/4 53 50 51 55 °C/W 1 2 58 59 61 63 °C/W 3 28 °C/W **MOUNTING METHOD 1 MOUNTING METHOD 3** P.C. Board Where Available P.C. Board with Copper Surface area is small 1-1/2" x 1-1/2" **Copper Surface** L = 1/2" **MOUNTING METHOD 2** Vector Push-In Terminals T-28 **Board Ground Plane**

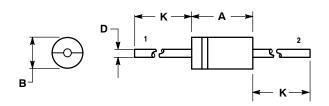
ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-----------|-------------|-----------------------|
| 1N5400G | Axial Lead* | 500 Units/Box |
| 1N5400RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5401G | Axial Lead* | 500 Units/Box |
| 1N5401RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5402G | Axial Lead* | 500 Units/Box |
| 1N5402RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5404G | Axial Lead* | 500 Units/Box |
| 1N5404RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5406G | Axial Lead* | 500 Units/Box |
| 1N5406RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5407G | Axial Lead* | 500 Units/Box |
| 1N5407RLG | Axial Lead* | 1200/Tape & Reel |
| 1N5408G | Axial Lead* | 500 Units/Box |
| 1N5408RLG | Axial Lead* | 1200/Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *This package is inherently Pb-Free.

PACKAGE DIMENSIONS

AXIAL LEAD CASE 267-05 ISSUE G



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

| | INC | HES | MILLIN | IETERS |
|-----|-------|-------|--------|--------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.287 | 0.374 | 7.30 | 9.50 |
| В | 0.189 | 0.209 | 4.80 | 5.30 |
| D | 0.047 | 0.051 | 1.20 | 1.30 |
| K | 1.000 | | 25.40 | |

STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE